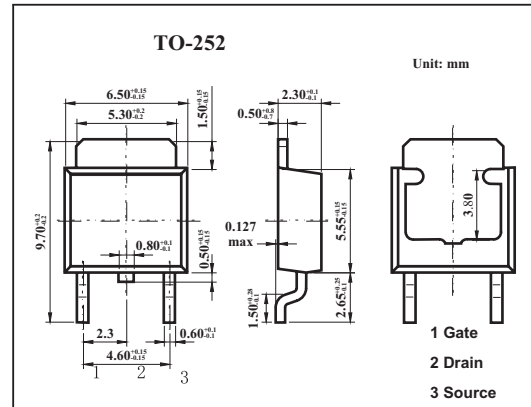


MOS Field Effect Transistor 2SK3377

■ Features

- Low on-resistance
 $R_{DS(on)1} = 44 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 10 \text{ A)}$
 $R_{DS(on)2} = 78 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.0 \text{ V, } I_D = 10 \text{ A)}$
- Low C_{iss} : $C_{iss} = 760 \text{ pF TYP.}$
- Built-in gate protection diode



■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Drain to source voltage	V_{DS}	60	V
Gate to source voltage	V_{GS}	± 20	V
Drain current	I_D	± 20	A
	I_{DP}^*	± 50	A
Power dissipation	P_D	$T_c=25^\circ\text{C}$	30
		$T_a=25^\circ\text{C}$	1.0
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

* $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit	
Drain cut-off current	I_{DSS}	$V_{DS}=60\text{V, } V_{GS}=0$			10	μA	
Gate leakage current	I_{GSS}	$V_{GS}=\pm 20\text{V, } V_{DS}=0$			± 10	μA	
Gate cutoff voltage	$V_{GS(off)}$	$V_{DS}=10\text{V, } I_D=1\text{mA}$	1.5	2.0	2.5	V	
Forward transfer admittance	$ Y_{fs} $	$V_{DS}=10\text{V, } I_D=10\text{A}$	5	10		S	
Drain to source on-state resistance	$R_{DS(on)1}$	$V_{GS}=10\text{V, } I_D=10\text{A}$		35	44	$\text{m}\Omega$	
	$R_{DS(on)2}$	$V_{GS}=4.0\text{V, } I_D=10\text{A}$		54	78	$\text{m}\Omega$	
Input capacitance	C_{iss}	$I_D=10\text{A, } V_{GS(on)}=10\text{V, } R_G=10\Omega, V_{DD}=30\text{V}$		760		pF	
Output capacitance	C_{oss}		$V_{DS}=10\text{V, } V_{GS}=0, f=1\text{MHz}$		150		pF
Reverse transfer capacitance	C_{rss}				71		pF
Turn-on delay time	t_{on}				13		ns
Rise time	t_r			170		ns	
Turn-off delay time	t_{off}			43		ns	
Fall time	t_f			34		ns	
Total Gate Charge	Q_G	$I_D=20\text{A, } V_{DD}=48\text{V, } V_{GS}=10\text{V}$		17		nC	
Gate to Source Charge	Q_{GS}			3.0		nC	
Gate to Drain Charge	Q_{GD}			4.7		nC	